Kalix® 2555 BK999

high performance polyamide

Kalix® 2555 is a bio-sourced, polyamide-based compound with 55% by weight glass reinforcement. This material is specifically formulated for high strength and stiffness applications where good impact resistance, outstanding dielectric properties, and excellent dimensional stability after molding are required. Its low viscosity and excellent flow properties make the material ideal for filling parts with thin-walled sections such as those encountered in the mobile electronics industry.

- Black: Kalix® 2555 BK 999

General		
Material Status	• Commercial: Active	
Availability	• Asia Pacific	
Filler / Reinforcement	• Glass Fiber, 55% Filler by Weight	
Features	• Fast Molding Cycle • Good Dimensional Stability • Good Electrical Properties • Good Impact Resistance • Good Surface Finish • High Flow	• High Stiffness • High Strength • Hot Water Moldability • Paintable • Platable
Uses	• Cell Phones • Electrical Parts	• Electrical/Electronic Applications • Thin-walled Parts
RoHS Compliance	• RoHS Compliant	
Appearance	• Black	• White
Forms	• Pellets	
Processing Method	• Injection Molding	• Water-Heated Mold Injection Molding

Physical	Typical Value	Unit	Test method
Specific Gravity	1.55		
Molding Shrinkage [1]			Internal Method
Across Flow	0.48	%	
Flow	0.15	%	
Water Absorption (24 hr, 23°C)	0.090	%	ASTM D570

Mechanical	Typical Value	Unit	Test method
Tensile Modulus	18500	MPa	ISO 527-1
Tensile Stress	225	MPa	ISO 527-2
Tensile Strain (Break)	3.5	%	ISO 527-2
Flexural Modulus	17000	MPa	ISO 178
Flexural Stress	360	MPa	ISO 178

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Impact	Typical Value	Unit	Test method
Notched Izod Impact Strength	20	kJ/m²	ISO 180/1A
Unnotched Izod Impact Strength	95	kJ/m²	ISO 180

Thermal	Typical Value	Unit	Test method
Deflection Temperature Under Load			ISO 75-2/A
1.8 MPa, Unannealed	205	°C	

Electrical	Typical Value	Unit	Test method
Dielectric Constant [2] (2.40 GHz)	3.70		ASTM D2520
Dissipation Factor [2] (2.40 GHz)	0.010		ASTM D2520

Flammability	Typical Value	Unit	Test method
Flame Rating (0.75 mm, ALL)	HB		UL 94

Additional Information

Typical values shown tested on Dry as Molded samples.

Standard Packaging and Labeling:

- Kalix® resin is packaged in foil lined, multiwall paper bags containing 25 kg (55 pounds) of material. Individual packages will be plainly marked with the product number, the color, the lot number, and the net weight.

Injection	Typical Value	Unit
Drying Temperature	80	°C
Drying Time	4.0 to 12	hr
Suggested Max Moisture	0.090	%
Rear Temperature	265 to 300	°C
Middle Temperature	280 to 330	°C
Front Temperature	280 to 330	°C
Processing (Melt) Temp	280 to 330	°C
Mold Temperature	50 to 130	°C

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Injection Notes

Storage:

- Kalix® compounds are shipped in moisture-resistant packages at moisture levels according to specifications. Sealed, undamaged bags should be preferably stored in a dry room at a maximum temperature of 50°C (122°F) and should be protected from possible damage. If only a portion of a package is used, the remaining material should be transferred into a sealable container. It is recommended that Kalix® resins be dried prior to molding following the recommendations found in this datasheet and/or in the Kalix® processing guide.

Drying:

- Kalix® is supplied in sealed bags. It should be dried before molding because excessive moisture content will result in reduced mechanical properties and processing issues, such as excessive nozzle drooling, foaming and splay visible on the molded parts.

- Use of a desiccant dryer with -40°C dewpoint is strongly suggested to ensure Kalix® material has reached optimum moisture content before processing.

Injection Molding:

- Set injection pressure to give rapid injection. Adjust holding pressure to one-half injection pressure. Set hold time to maximize part weight. Transfer from injection to hold pressure at the screw position just before the part is completely filled.
- For light colors use lower melt temperature if possible. If operating in the 330°C melt temperature range, keep residence times below 5 minutes.
- Actual mold temperatures of 80°C or above are recommended to improve flow and part surface finish. The use of mold temperatures below 80°C is safe for mechanical properties but may result in higher necessary injection pressure and inferior surface finish.

Notes

Typical properties: these are not to be construed as specifications.

[1] Solvay Test Method. Shrink rates can vary with part design and processing conditions. Please consult a Solvay Technical Representative for more information.

[2] Method B

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